

**Micro Commercial Components** 

Micro Commercial Components 20736 Marilla Street Chatsworth

CA 91311

Phone: (818) 701-4933 Fax: (818) 701-4939

# SD101A THRU SD101C

**Small Signal** 

**Schottky Diodes** 

### **Features**

- Lead Free Finish/Rohs Compliant (Note1) ("P"Suffix designates Compliant. See ordering information)
- Low Reverse Recovery Time
- Low Reverse Capacitance
- Low Forward Voltage Drop
- Guard Ring Construction for Transient Protection

### Mechanical Data

• Case: DO-35, Glass

• Terminals: Solderable per MIL-STD-202, Method 208

Polarity: Indicated by Cathode Band

Moisture Sensitivity: Level 1 per J-STD-020C

### Maximum Ratings @ 25°C Unless Otherwise Specified

Characteristic	Symbol	SD101A	SD101B	SD101C
Peak Repetitive Reverse Voltage	Vrrm			
Working Peak Reverse Voltage	VRWM	60V	50V	40V
DC Blocking Voltage	$V_R$			
RMS Reverse Voltage	V <sub>R(RMS)</sub>	42V	35V	28V
Maximum sigle cycle surge 10us square wave	Ігѕм		2.0A	
Power Dissipation(Note 2)	Pd	400mW		
Thermal Resistance, Junction to Ambient	R	300K/W		
Junction Tmperature	Tj	125°C		
Operation/Storage Temp. Range	Тѕтс	-55 to +150°C		

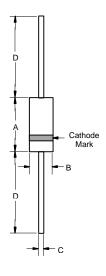
#### Electrical Characteristics @ 25°C Unless Otherwise Specified

Parameter		Symbol	Max	Test Condition
Leakage Current	SD101A		200nA	Vr=50V
	SD101B	lπ	200nA	VR=40V
	SD101C		200nA	VR=30V
Maximum Forward	SD101A		0.41V	
Voltage Drop	SD101B		0.4V	
	SD101C	VF	0.39V	I <sub>F</sub> =1mA
	SD101A	VF	1 V	I <sub>F</sub> =15mA
	SD101B		0.95V	
	SD101C		0.9V	
Junction Cap.	SD101A		2.0pF	
	SD101B	Cj	2.1pF	V <sub>R</sub> =0V, f=1.0MHz
	SD101C		2.2pF	
Reverse Recovery Time		t <sub>rr</sub>	1ns	I <sub>F</sub> =I <sub>R</sub> =50mA, recover to
				200mA/0.11R

Note: 1. Lead in Glass Exemption Applied, see EU Directive Annex 5.

2. Valid provided that electrodes are kept at ambient temperature

### DO-35



DIMENSIONS					
	INCHES		MM		
DIM	MIN	MAX	MIN	MAX	NOTE
Α		.166		4.2	
В		.079		2.00	
С		.020		.52	
D	1.000		25.40		

## SD101A thru SD101C



Figure 1. Typical variation of forward. current vs.fwd. Voltage for primary conduction through the schottky barrier

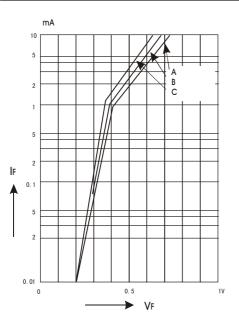


Figure 3. Typical variation of reverse current at versus temperature

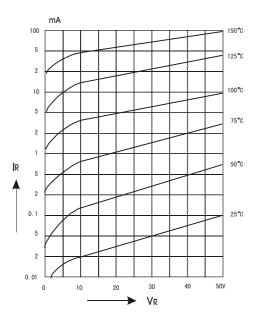


Figure 2. Typical forward conduction curve of combination Schottky barrier and PN junction guard ring

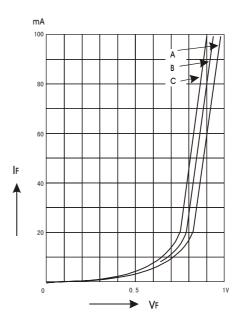
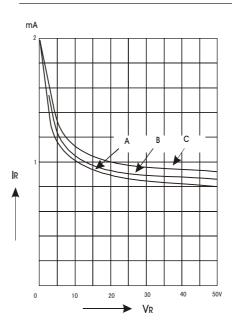


Figure 4. Typical capacitance curve as a function of reverse voltage





**Micro Commercial Components** 

### **Ordering Information**

Device	Packing	
(Part Number)-TP	Tape&Reel 10Kpcs/Reel	
(Part Number)-AP	Ammo Packing;5Kpcs/AmmoBox	
(Part Number)-BP	Bulk;500pcs/Bag	

#### \*\*\*IMPORTANT NOTICE\*\*\*

Micro Commercial Components Corp. reserve the right to make changes without further notice to any product herein to make corrections, modifications, enhancements, improvements, or other changes.
Micro Commercial Components Corp. does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. The user of products in such applications shall assume all risks of such use and will agree to hold Micro Commercial Components Corp. and all the companies whose products are represented on our website, harmless against all damages.

#### \*\*\*APPLICATIONS DISCLAIMER\*\*\*

Products offer by *Micro Commercial Components Corp* . are not intended for use in Medical,

Aerospace or Military Applications.